

UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/917,578 07/28/2001		Arnold E. Goldman	GCD 98-55-US	1058	
7	590 09/25/2002				

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EXAMINER HINDI, OMAR Z ART UNIT PAPER NUMBER 2873

DATE MAILED: 09/25/2002

Please find below and/or attached an Office communication concerning this application or proceeding.

.` Office Action Summary		Application	n No.	Applicant(s)				
		09/917,57	8	GOLDMAN ET AL.	120			
		Examiner		Art Unit				
		Omar Z. H		2873				
Period fo	The MAILING DATE of this communication or Reply	appears on the	cover sheet with the o	correspondence addres	s			
THE - Exte after - If the - If NO - Failu - Any	ORTENED STATUTORY PERIOD FOR RE MAILING DATE OF THIS COMMUNICATIC insons of time may be available under the provisions of 37 CFI SIX (b) MORTHS from the mailing date of this communication pround for reply specified above a tea than thinny (10 days, a pround for reply specified above as the maining MORTHS) are to reply within the set or extended period for reply will, by street to reply within the set or extended period for reply will, by streety received by the Office later than three months after the med patent term adjustment. See 37 CFR 1.704(b).	ON. R 1.136(a). In no eve i. I reply within the statu- iriod will apply and will latute, cause the appl	ent, however, may a reply be tin story minimum of thirty (30) day Il expire SIX (6) MONTHS from ication to become ABANDONE	nely filed s will be considered timely. the mailing date of this commu	nication.			
1)⊠	Responsive to communication(s) filed on	Amendment A						
2a)□	This action is FINAL . 2b)⊠	This action is	non-final.					
3)	Since this application is in condition for all				erits is			
Disposit	closed in accordance with the practice un- ion of Claims	der Ex parte Q	uayle, 1935 C.D. 11, 4	153 O.G. 213.				
4)⊠	Claim(s) 1-21 is/are pending in the applica	ation.						
	4a) Of the above claim(s) is/are with	drawn from cor	nsideration.					
5)	Claim(s) is/are allowed.							
6)⊠ Claim(s) <u>1-21</u> is/are rejected.								
7)	7) Claim(s)is/are objected to.							
,	Claim(s) are subject to restriction ar	nd/or election re	equirement.					
	ion Papers							
	The specification is objected to by the Exan		_					
10)⊠	The drawing(s) filed on 28 July 2001 is/are:							
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).								
11)	The proposed drawing correction filed on			oved by the Examiner.				
	If approved, corrected drawings are required i		fice action.					
,	The oath or declaration is objected to by the	e Examiner.						
-	under 35 U.S.C. §§ 119 and 120							
	Acknowledgment is made of a claim for for	reign priority un	der 35 U.S.C. § 119(a	a)-(d) or (f).				
a)	□ All b)□ Some * c)□ None of:							
1. Certified copies of the priority documents have been received.								
	2. Certified copies of the priority documents have been received in Application No							
*;	 Copies of the certified copies of the application from the Internationa See the attached detailed Office action for a 	Bureau (PCT	Rule 17.2(a)).		ge			
14) 🛛 .	Acknowledgment is made of a claim for dom	nestic priority ur	nder 35 U.S.C. § 119(e) (to a provisional app	olication).			
	a) The translation of the foreign language Acknowledgment is made of a claim for don							
Attachmer	•	priority u						
1) Noti 2) Noti	ce of References Cited (PTO-892) ce of Draftsperson's Patent Drawing Review (PTO-948 rmation Disclosure Statement(s) (PTO-1449) Paper No			y (PTO-413) Paper No(s) Patent Application (PTO-15 ction .	2)			

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DETAILED ACTION

Claim Rejections - 35 USC § 103

- The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior at are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- Claim 1 is rejected under 35 U.S.C. 103(a) as being unpatentable over Fujihara et al (5065011) in view of Takahashi (5621835).

Fujihara discloses as in claim 1, a vehicle for enabling attachment of an optic fiber (fig.2) to a multi-integrated optic chip (fig.2; 30,31,32 combined) in optical communication therewith, and for maintaining alignment of the fiber at its end adjacent the chip (fig.2; 37 and 37a) a sleeve (fig.2; 34) having a symmetrically-shaped cavity (fig.2; element 35) bounded by termini (fig.2 surface 35a and the adjacent surface of the same figure) which respectively interface with the chip and the fiber. Fujihara does not disclose the use of adhesive disposed within the cavity and symmetrically bonding the fiber to the chip. Within the same field of invention, Takahashi discloses the use of adhesive disposed within the cavity (fig.4 and 6; 19) and symmetrically bonding the fiber (fig.6; 8) to the chip (fig.6; 9'). It would have been obvious for one skilled in the art at the time the invention was made to bond the optical fiber with the chip using adhesive for the purpose of preserve the bonding of chip and the fiber and protection from the gravitational and wicking effects.

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 Claim 2 is rejected under 35 U.S.C. 103(a) as being unpatentable over Fujihara et al (5065011) in view of Takahashi (5621835).

Fuilhara discloses as in claim 2, a vehicle for enabling attachment of an optic fiber (fig.2) to a multi-integrated optic chip (fig.2: 30.31.32 combined) in optical communication therewith, and for maintaining alignment of the fiber at its end adjacent the chip (fig.2; 37 and 37a), comprising; a sleeve (fig.2; 34) which has a symmetrically-shaped cavity (fig.2 surface 35) bounded by termini (fig.2 surface 35a and the adjacent surface of the same figure) that respectively interface with the chip and the fiber and in which cavity has an axis and is internally bounded by a wall (fig.2; 35a) which is substantially centered on the axis (fig.2) and which extends from chip-interfacing terminus to fiber-interfacing terminus, termini are centered on the axis (fig.2), and a line, lying within any plane intersecting the axis at right angles thereto and terminating in cavity wall, is bisected into two equal segments (this is applicable to figure 2; elements 30,31,32 combined). Fujihara does not disclose the use of adhesive disposed within the cavity and symmetrically bonding the fiber to the chip. Within the same field of invention. Takahashi discloses the use of adhesive disposed within the cavity (fig.4 and 6; 19) and symmetrically bonding the fiber (fig.6; 8) to the chip (fig.6; 9'). It would have been obvious for one skilled in the art at the time the invention was made to bond the optical fiber with the chip using adhesive for the purpose of preserve the bonding of chip and the fiber and protection from the gravitational and wicking effects.

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Claims 3-10 are rejected under 35 U.S.C. 103(a) as being unpatentable over Fujihara et al (5065011) in view of Takahashi (5621835).

Fujihara discloses as in claim 3, a vehicle for enabling attachment of an optic fiber (fig.2) to a multi-integrated optic chip (fig.2; 30,31,32 combined) in optical communication therewith, and for maintaining alignment of the fiber at its end adjacent the chip (fig.2; 37 and 37a) a sleeve (fig.2; 34) having a symmetrically-shaped cavity (fig.2; element 35) bounded by termini (fig.2 surface 35a and the adjacent surface of the same figure) which respectively interface with the chip and the fiber which is configured to fit onto the chip and is disposed to accept the fiber (fig.2). Fujihara does not disclose the use of adhesive disposed within the cavity and symmetrically bonding the fiber to the chip the fiber configured to fit onto the chip. Within the same field of invention,

Takahashi discloses the use of adhesive disposed within the cavity (fig.4 and 6; 19) and symmetrically bonding the fiber (fig.6; 8) to the chip (fig.6; 9'). It would have been obvious for one skilled in the art at the time the invention was made to bond the optical fiber with the chip using adhesive for the purpose of preserve the bonding of chip and the fiber and protection from the gravitational and wicking effects.

Fujihara discloses as in claim 4, a cavity has an axis and is internally bounded by a wall (fig.2; 35a) which is substantially centered on the axis (fig.2) and which extends from chip-fitting terminus to fiber-accepting terminus, termini are centered on the axis (fig.2), and a line, lying within any plane intersecting the axis at right angles thereto and terminating in cavity wall, is bisected into two equal segments (this is applicable to figure 2; elements 30.31.32 combined).

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Fujihara discloses as in claim 5, cavity wall slopes from chip-fitting terminus to fiber-accepting terminus, (fig.2).

Claim 6 is rejected under 35 U.S.C. 103(a) as applied to claim 4, in view of Takahashi (5621835), as being well known in the art.

Takahashi discloses as in claim 6 the purpose of using adhesive material in the symmetrical cavity, but it would be obvious to one skilled in the art to use adhesive material for the purpose of preserve the bonding of chip and the fiber and protection from the gravitational and wicking effects, as a common knowledge in the art.

Fujihara discloses as in claim 7, cavity wall is shaped a truncated right circular cone. (fig.3).

Fujihara discloses as in claim 8, cavity wall is shaped a truncated right circular pyramid, (fig.3).

Claim 9 is rejected under 35 U.S.C. 103(a) as applied to claim 4, in view of Takahashi (5621835), as being well known in the art.

Takahashi discloses as in claim 9 the use of a sleeve, but it would be obvious to one skilled in the art to use a temporarily sleeve for the purpose of injecting the adhesive material into the cavity and removing it after curing, as a common knowledge in the art.

Takahashi discloses as in claim 10, sleeve (fig.6; 4) is permanently attached to adhesive (19) and the chip (9'). Figure 6 shows the final product where it indicates that the sleeve is permanently attached to the adhesive and the chip.

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Claims 11-16 are rejected under 35 U.S.C. 103(a) as being unpatentable over Fuiihara et al (5065011) in view of Takahashi (5621835).

A method for attaching an optic fiber to an optic chip (fig.2; 30,31,32 combined) and for maintaining alignment of the fiber at its end adjacent the chip, comprising the steps of positioning a sleeve (fig2; 34) having a symmetrically shaped cavity on the chip (fig.2; element 35). Fujihara does not disclose placing an adhesive into the sleeve cavity; inserting the fiber into the cavity; securing the fiber to the chip; and curing the adhesive. Within the same field of invention, Takahashi discloses placing an adhesive into the sleeve cavity (fig.4 and 6; 19); inserting the fiber into the cavity; securing the fiber to the chip (fig.6; 8 and 9') and curing the adhesive (col.2 lines 8-10). It would have been obvious for one skilled in the art at the time the invention was made use the method of bonding the optical fiber with the chip using adhesive for the purpose of preserve the bonding of chip and the fiber and protection from the gravitational and wicking effects.

Takahashi disclose as in claim 12, a method further comprising the step of aligning the fiber (fig.6; 8) within the cavity (19) and positioning the fiber end adjacent to the chip (fig.6; 8 near 9').

Claim 9 is rejected under 35 U.S.C. 103(a) as applied to claim 4, in view of Takahashi (5621835), as being well known in the art.

Takahashi discloses as in claim 13 the use of a sleeve, but it would be obvious to one skilled in the art to use a temporarily sleeve for the purpose of injecting the

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adhesive material into the cavity and removing it after curing, as a common knowledge in the art.

Takahashi discloses as in claim 14, a method of leaving the sleeve (fig.6; 4) is securely attached to adhesive (19) and the chip (9') after adhesive has cured (col.2 lines 8-10). Figure 6 shows the final product where it indicates that the sleeve is permanently attached to the adhesive and the chip.

Fujihara discloses as in claim 15, a method further comprising the step of providing the sleeve cavity with a truncated pyramid configuration (fig.2 and 3).

Fujihara discloses as in claim 16, a method further comprising the step of providing the sleeve cavity with a truncated right circular cone configuration (fig.2 and 3).

Claims 17-21 are rejected under 35 U.S.C. 103(a) as being unpatentable over Fujihara et al (5065011) in view of Takahashi (5621835).

Fujihara discloses as in claim 17, a method for attaching an optic fiber (fig.2) to an optic chip (fig.2; 30,31,32 combined) for maintaining alignment of the fiber at its end adjacent the chip (fig.2; 37 and 37a), comprising the steps of utilizing a sleeve (fig.2; 34) having a symmetrically shaped cavity (fig.2; element 35). Fujihara does not disclose placing an adhesive into the sleeve cavity; positioning the sleeve onto the chip; inserting the fiber into the cavity aligning the fiber within the cavity and positioning the fiber end adjacent the chip; securing the fiber to the chip; and curing the adhesive. Within the same field of invention, Takahashi discloses placing an adhesive into the sleeve cavity (fig.4 and 6; 19); positioning the sleeve onto the chip (fig.6; 8 onto 9'); inserting the fiber into the cavity (fig.6; 8 into 19) aligning the fiber within the cavity and positioning the fiber end adjacent the chip;

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securing the fiber to the chip (fig.6); and curing the adhesive (col.2 lines 8-10). It would have been obvious for one skilled in the art at the time the invention was made use the method of bonding the optical fiber with the chip using adhesive for the purpose of preserve the bonding of chip and the fiber and protection from the gravitational and wicking effects.

Takahashi discloses as in claim 18 the use of a sleeve, but it would be obvious to one skilled in the art to use a temporarily sleeve for the purpose of injecting the adhesive material into the cavity and removing it after curing, as a common knowledge in the art.

Takahashi discloses as in claim 19, a method of leaving the sleeve (fig.6; 4) is securely attached to adhesive (19) and the chip (9') after adhesive has cured (col.2 lines 8-10). Figure 6 shows the final product where it indicates that the sleeve is permanently attached to the adhesive and the chip.

Fujihara discloses as in claim 20, a method further comprising the step of providing the sleeve cavity with a truncated pyramid configuration (fig.2 and 3).

Fujihara discloses as in claim 21, a method further comprising the step of providing the sleeve cavity with a truncated right circular cone configuration (fig.2 and 3).

Conclusion

 The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. The following reference is cited for having limitation such as pigtail assembly Anderson (4969702). Application/Control Number: 09/917,578 Art Unit: 2873

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Omar Z. Hindi whose telephone number is (703) 305-6845. The examiner can normally be reached on Monday-Thursday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Georgia Y. Epps can be reached on (703) 308-4883. The fax phone numbers for the organization where this application or proceeding is assigned are (703) 308-7724 for regular communications and (703) 308-7724 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703)308-0956.

Omar Z. Hindi Examiner Art Unit 2873

OH September 17, 2002

Georgia Epps

Technology Center 2800